# **ON Semiconductor**

## Is Now



To learn more about onsemi™, please visit our website at www.onsemi.com

onsemi and ONSEMI. and other names, marks, and brands are registered and/or common law trademarks of Semiconductor Components Industries, LLC dba "onsemi" or its affiliates and/or subsidiaries in the United States and/or other countries. onsemi owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of onsemi product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. onsemi reserves the right to make changes at any time to any products or information herein is provided "as-is" and onsemi makes no warranty, representation or guarantee regarding the accuracy of the information, product features, availability, functionality, or suitability of its products for any particular purpose, nor does onsemi assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. Buyer is responsible for its products and applications using onsemi products, including compliance with all laws, regulations and safety requirements or standards, regardless of any support or applications information provided by onsemi. "Typical" parameters which may be provided in onsemi data sheets and/ or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "Typicals" must be validated for each customer application by customer's technical experts. onsemi does not convey any license under any of its intellectual property rights nor the rights of others. onsemi products are not designed, intended, or authorized for use as a critical component in life support systems or any FDA Class 3 medical devices or medical devices with a same or similar classification in a foreign jurisdiction or any devices intended for implantation in the human body. Should Buyer purchase or use onsemi products for any such unintended or unauthorized application,

# **NGTD23T120F2**

## **IGBT** Die

Trench Field Stop II IGBT Die for motor drive and inverter applications.

#### **Features**

- Extremely Efficient Trench with Field Stop Technology
- Low V<sub>CE(sat)</sub> Loss Reduces System Power Dissipation

#### **Typical Applications**

- Industrial Motor Drives
- Solar Inverters
- UPS Systems
- Welding

## **MAXIMUM RATINGS**

Parameter	Symbol	Value	Unit
Collector–Emitter Voltage, T <sub>J</sub> = 25°C	V <sub>CE</sub>	1200	V
DC Collector Current, limited by T <sub>J(max)</sub>	I <sub>C</sub>	(Note 1)	Α
Pulsed Collector Current (Note 2)	I <sub>C, pulse</sub>	120	Α
Gate-Emitter Voltage	$V_{GE}$	±20	V
Maximum Junction Temperature	$T_J$	-55 to +175	°C
Short Circuit Withstand Time, $V_{GE} = 15 \text{ V}, V_{CE} = 500 \text{V}, T_J \le 150^{\circ}\text{C}$	T <sub>SC</sub>	10	μS

Stresses exceeding those listed in the Maximum Ratings table may damage the device. If any of these limits are exceeded, device functionality should not be assumed, damage may occur and reliability may be affected.

- 1. Depending on thermal properties of assembly.
- 2.  $T_{pulse}$  limited by  $T_{jmax}$ , 10  $\mu s$  pulse,  $V_{GE}$  = 15 V.

#### **MECHANICAL DATA**

Parameter	Value	Unit	
Die Size	5375 x 4175	μm <sup>2</sup>	
Emitter Pad Size	See die layout	μm <sup>2</sup>	
Gate Pad Size	405 x 660	μm <sup>2</sup>	
Die Thickness	5	mils	
Wafer Size	150	mm	
Top Metal	5 μm AlSi		
Back Metal	2 μm TiNiAg		
Max possible chips per wafer	546		
Passivation frontside	Oxide-Nitride		
Reject ink dot size	25 mils		
Recommended storage environment: In original container, in dry nitrogen, or temperature of 18–28°C, 30–65%RH	Type: Bare Wafer in Jar Storage time: < 36 months	Type: Die on tape in ring–pack Storage time: < 3 months	

#### **ORDERING INFORMATION**

Device	Inking?	Shipping
NGTD23T120F2WP	Yes	Bare Wafer in Jar
NGTD23T120F2SWK	Yes	Sawn Wafer on Tape

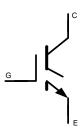


## ON Semiconductor®

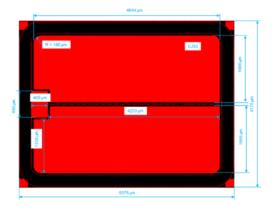
www.onsemi.com

 $V_{RCE}$  = 1200 V I<sub>C</sub> = Limited by T<sub>J(max)</sub>

#### **IGBT DIE**



#### **DIE OUTLINE**



## NGTD23T120F2

**ELECTRICAL CHARACTERISTICS** (T<sub>J</sub> = 25°C, unless otherwise specified)

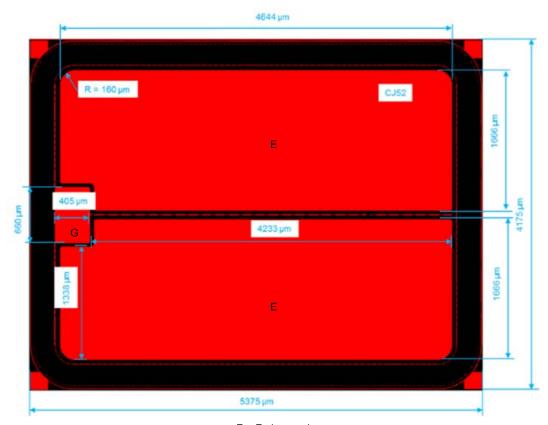
Parameter	Test Conditions	Symbol	Min	Тур	Max	Units
STATIC CHARACTERISTICS						
Collector-Emitter Breakdown Voltage	$V_{GE} = 0 \text{ V, } I_{C} = 500  \mu\text{A}$	V <sub>(BR)CES</sub>	1200			V
Collector–Emitter Saturation Voltage	V <sub>GE</sub> = 15 V, I <sub>C</sub> = 25 A	V <sub>CE(sat)</sub>		1.9	2.2	V
Gate-Emitter Threshold Voltage	$V_{GE} = V_{CE}, I_{C} = 400 \mu A$	V <sub>GE(TH)</sub>	4.5	5.5	6.5	V
Collector-Emitter Cutoff Current	V <sub>GE</sub> = 0 V, V <sub>CE</sub> = 1200 V	I <sub>CES</sub>			1.0	mA
Gate Leakage Current	V <sub>GE</sub> = 20 V, V <sub>CE</sub> = 0 V	I <sub>GES</sub>			200	nA

#### **DYNAMIC CHARACTERISTICS**

Input Capacitance		C <sub>ies</sub>	5250	pF
Output Capacitance	$V_{CE} = 20 \text{ V}, V_{GE} = 0 \text{ V}, f = 1$ MHz	C <sub>oes</sub>	170	pF
Reverse Transfer Capacitance		C <sub>res</sub>	100	pF

Product parametric performance is indicated in the Electrical Characteristics for the listed test conditions, unless otherwise noted. Product performance may not be indicated by the Electrical Characteristics if operated under different conditions.

## **DIE LAYOUT**



$$\begin{split} E &= \text{Emitter pad} \\ G &= \text{Gate pad} \\ \text{All dimensions in } \mu \text{m} \end{split}$$

#### NGTD23T120F2

#### **Further Electrical Characteristic**

Switching characteristics and thermal properties are depending strongly on module design and mounting technology and can therefore not be specified for a bare die.

ON Semiconductor and the (III) are registered trademarks of Semiconductor Components Industries, LLC (SCILLC) or its subsidiaries in the United States and/or other countries. SCILLC owns the rights to a number of patents, trademarks, copyrights, trade secrets, and other intellectual property. A listing of SCILLC's product/patent coverage may be accessed at www.onsemi.com/site/pdf/Patent-Marking.pdf. SCILLC reserves the right to make changes without further notice to any products herein. SCILLC makes no warranty, representation or guarantee regarding the suitability of its products for any particular purpose, nor does SCILLC assume any liability arising out of the application or use of any product or circuit, and specifically disclaims any and all liability, including without limitation special, consequential or incidental damages. "Typical" parameters which may be provided in SCILLC date seets and/or specifications can and do vary in different applications and actual performance may vary over time. All operating parameters, including "typicals" must be validated for each customer application by customer's technical experts. SCILLC does not convey any license under its patent rights nor the rights of others. SCILLC products are not designed, intended, or authorized for use as components in systems intended for surgical implant into the body, or other applications intended to support or sustain life, or for any other application in which the failure of the SCILLC product could create a situation where personal injury or death may occur. Should Buyer purchase or use SCILLC products for any such unintended or unauthorized application, Buyer shall indemnify and hold SCILLC and its officers, employees, subsidiaries, affiliates, and distributors harmless against all claims, costs, damages, and expenses, and reasonable attorney fees arising out of, directly or indirectly, any claim of personal injury or death associated with such unintended or unauthorized use, even if such claim alleges that SCILLC was negligent regarding the design or manufacture of the part. SCILLC is an Equal Opportunity/Affirmative Action Employer. This literature is subject to all applicable copyright laws and is not for resale in any manner.

#### **PUBLICATION ORDERING INFORMATION**

#### LITERATURE FULFILLMENT

Literature Distribution Center for ON Semiconductor P.O. Box 5163, Denver, Colorado 80217 USA Phone: 303-675-2175 or 800-344-3860 Toll Free USA/Canada Fax: 303-675-2176 or 800-344-3867 Toll Free USA/Canada Email: orderlit@onsemi.com

N. American Technical Support: 800-282-9855 Toll Free USA/Canada Europe, Middle East and Africa Technical Support:

Phone: 421 33 790 2910 Japan Customer Focus Center Phone: 81-3-5817-1050

ON Semiconductor Website: www.onsemi.com

Order Literature: http://www.onsemi.com/orderlit

For additional information, please contact your local Sales Representative

# **Mouser Electronics**

**Authorized Distributor** 

Click to View Pricing, Inventory, Delivery & Lifecycle Information:

# onsemi:

NGTD23T120F2WP NGTD23T120F2SWK